

SST-10-UV

Surface Mount UV LED

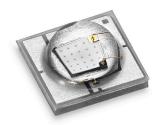


Table of Contents

Technology Overview2
Binning Structure3
Ordering Information4
Ordering Bin Kits 4
Optical & Electrical Characteristics
Typical Spectrum7
Radiation Pattern7
Thermal Resistance8
Mechanical Dimensions 9
Tape adn Reel Outline 10
Soldering Profile 11
Packaging and shipping specifications 12
Revision History 13

Features:

- High Power UV LED with peak wavelengths 365 nm, 385 nm, 395 nm and 405 nm
- Industry standard 3.5 mm x 3.5 mm package
- 130° viewing angle
- Low Thermal Resistance: 1.4 °C/W
- Built-in ESD Protection
- Environmentally friendly: REACH, RoHS and Halogen compliant

Applications:

- Curing- inks, coating and adhesives
- Photocatalytic air/water purification
- Medical and Analytic instrumentation
- Diagnostics
- Fluorescence Imaging





Technology Overview

Luminus LEDs benefit from innovations in device technology, chip packaging and thermal management. This suite of technologies give engineers and system designers the freedom to develop solutions high both in power and in efficiency.

Luminus Surface Mount LED Technology

Luminus' vertical chip technology enables uniform and high brightness over the entire chip surface.

Thermal management is critical in high power LED applications. With a thermal resistance (R_{th}) from junction to board of 1.4 °C/W, the SST-10 has one of the lowest thermal resistances of UV LEDs in the market. The low R_{th} , along with Luminus vertical chip techology allows users to drive the LEDs at high current densities while maintaining a low junction temperature, thereby resulting in brighter solutions and longer lifetimes.

Reliability

Luminus LEDs are one of the most reliable light sources in the world. They pass a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been qualified for use in high power and high current applications. Luminus UV LEDs are designed for the most demanding applications with median lifetimes exceeding 30,000 hours.

Environmental Benefits

Luminus LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All Luminus LEDs are RoHS and Halogen compliant and free of hazardous materials, including lead and mercury.



Binning Structure

SST-10-UV LEDs are specified for flux and peak wavelength at a drive current of 500 mA with a 20 ms pulse at 25°C and placed into one of the following Flux Bins and Peak Wavelength Bins.

Flux Bins¹

Color	Power Flux Bin (FF)	Minimum Flux (W)	Maximum Flux (W)
	E	720	810
UV	F	810	900
	G	900	990
	Н	990	1080
	I	1080	1170

Note 1: Luminus maintains a +/- 6% tolerance on power measurements.

Peak Wavelength Bins

Color	Wavelength Bin (WWW)	Minimum Wavelength (nm)	Maximum Wavelength (nm)
	365	365	370
	370	370	375
	380	380	385
107	385	385	390
UV	390	390	395
	395	395	400
	400	400	405
	405	405	410



Ordering Information

Products	Ordering Part Number	Description	
SST-10-UV	SST-10-UV-A130 <i>-FFWWW</i> -00	LIVLED in a 2525 surface mount package with a 120 degree molded long	
331-10-07	SST-10-UV-B130- <i>FFWWW</i> -00	UV LED in a 3535 surface mount package with a 130 degree molded len	

Part Number Nomenclature

SST —	10 —	UV	 X130	FFWWW-00

Product Family	Chip Area	Color	Package Configuration 1	Bin Kit ^{2,3}
SST: Surface Mount package	10: 1 mm²	UV = Ultraviolet	A130 : "A" solder pad layout and 130 ° lens B130 : "B" solder pad layout and 130 ° lens	See ordering bin kits table below for complete bin definition

Note 1: Refer to drawings on page 9 for details on "A" and "B" solder pad layouts

Note 2: A Bin Kit represents a group of flux and wavelength bins that are shippable for a given ordering part number. Individual bins are not orderable..

Note 3: Flux Bin listed is minimum bin shipped - higher bins may be included at Luminus' discretion

Ordering Bin Kits

	Lumino	ous Flux		Ordering
Wavelength Range (nm)	Bin Kit Flux Code	Min. Flux (mW)	Wavelength Bins	Bin Kit Number
265 275	E	720	365, 370	E365-00
365-375	F	810	365, 375	F365-00
380-390	G	900	380, 385	G385-00
390-400	G	900	390, 395	G395-00
400-410	F	810	400,405	F405-00
				-



Optical & Electrical Characteristics ($T_{hs} = 25$ °C)

υν						
Parameter	Symbol		Valu	ıes ⁴		Unit
Peak Wavelength Range	λ	365-375	380-390	390-400	400-410	nm
Test Current for binning ⁵	I	500	500	500	500	mA
Peak Wavelength Typ.	$\lambda_{_{p}}$	370	385	395	405	nm
	$V_{_{\rm Fmin}}$	3.0	3.0	3.0	3.0	V
Forward Voltage	$V_{_{\rm F}}$	3.7	3.4	3.3	3.3	V
	V _{F max}	4.0	4.0	4.0	4.0	V
Radiometric Flux ⁶	Φ_{typ}	875	1015	1015	930	mW
FWHM at 50% of Φ	Δλ _{1/2}	10	10	10	10	nm
Viewing Angle	2Φ _{1/2}	130	130	130	130	degrees

Parameter	Symbol	Values
Absolute Maximum Current (CW) 7	 max	365 nm- 1A 385-405 nm- 1.5 A
Maximum Junction Temperature ⁷	T _{jmax}	100 °C
Storage Temperature Range	T _s	-40 to +100 °C
Soldering Temperature	Tsld	JEDEC J-STD-020C, 260 ℃
ESD Sensitivity (HBM)	V _B	6000 V

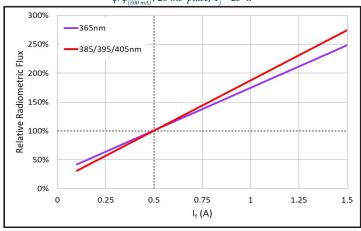
- Note 4: Unless otherwise noted, values listed are typical. Devices are production tested and specified at 500 mA with a 20 ms pulse at 25°C.
- Note 5: While SST-10-UV devices are tested at 500 mA, they can be driven at CW currents ranging from 200 mA to 1.5 A and at duty cycles ranging from 1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirements.
- Note 6: Typical radiometric flux is for reference only. Minimum flux values are guaranteed based on the bin kit ordered. For product roadmap and future performance of devices, contact Luminus.
- Note 7: SST-10-UV LEDs are designed for operation to an absolute maximum current as specified above. Product lifetime data is specified at or below maximum drive current. Sustained operation beyond absolute maximum currents will result in a reduction of device life time. Actual device lifetimes will also depend on junction temperature and operation beyond maximum junction temperature is not recommended. Contact Luminus for lifetime derating curves and for further information. In pulsed operation, rise time from 10-90% of forward current should be longer than 0.5 µseconds.



Optical & Electrical Characteristics

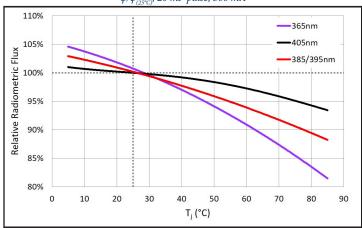
Relative Power vs. Forward Current

 $\varphi/\varphi_{(500 \text{ mA})}$, 20 ms pulse, $T_i = 25$ °C



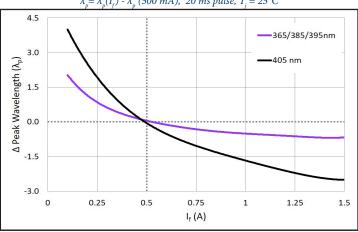
Relative Power vs. Junction Temperature

 $\varphi/\varphi_{(25^{\circ}C)}$, 20 ms pulse, 500 mA



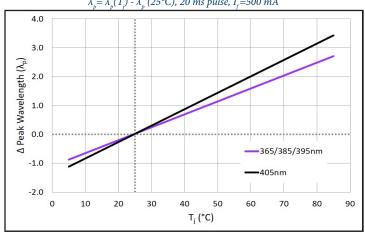
Peak Wavelength Shift vs. Forward Current

 $\lambda_o = \lambda_o(I_f) - \lambda_o$ (500 mA), 20 ms pulse, $T_i = 25$ °C

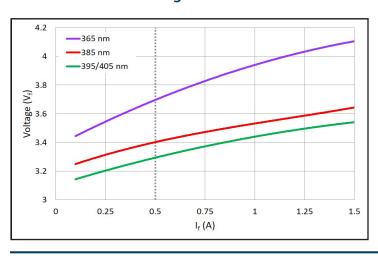


Peak Wavelength Shift vs. Junction Temperature

 $\lambda_{s} = \lambda_{s}(T_{s}) - \lambda_{s}$ (25°C), 20 ms pulse, $I_{s} = 500$ mA

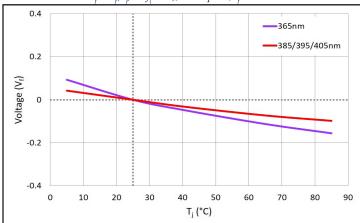


Forward Voltage vs Forward Current



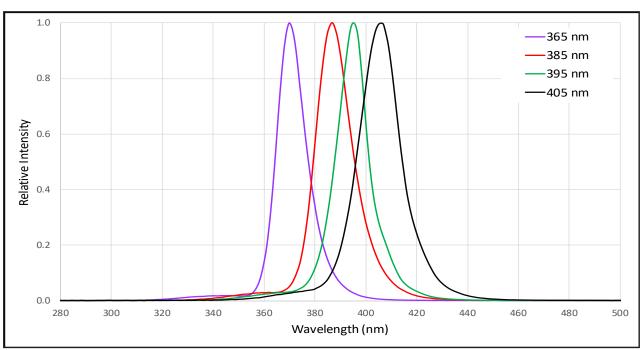
Forward Voltage Shift vs. Junction Temperature

 $\Delta V_{\epsilon} = V_{\epsilon}(T_{\epsilon}) - V_{f,\epsilon}(T_{\epsilon}) - V_{f,\epsilon}(T_{\epsilon}) = 500 \text{ mA}$

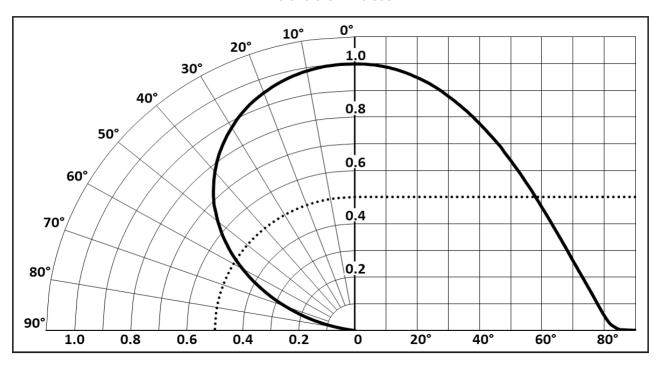




Typical Spectrum⁸



Radiation Pattern⁹

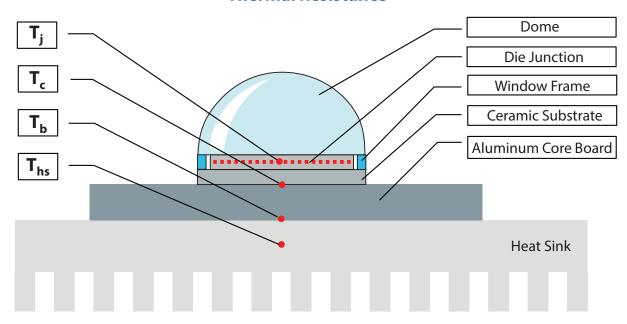


Note 8: Typical spectrum at 500 mA drive current.

Note 9: Detailed information on radiation pattern including ray trace files can be found at: http://www.luminus.com



Thermal Resistance



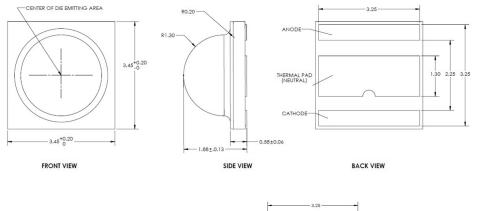
 T_{hs} definition = 3 mm from core-board

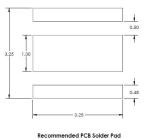
$R_{\theta j-b}^{10}$	1.4 °C/W
-----------------------	----------

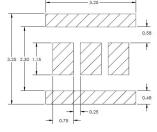
Note 10: Electrical thermal resistance based on input electrical power at 500 mA and measured per JESD51-14



Mechanical Dimensions - A130 package

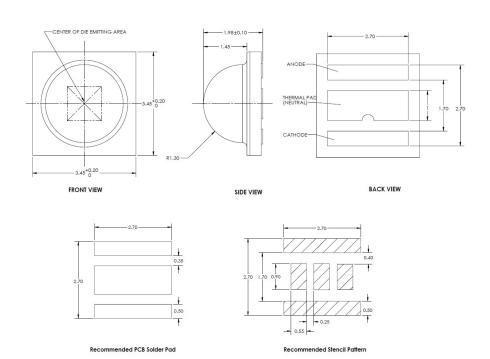






DWG-002848

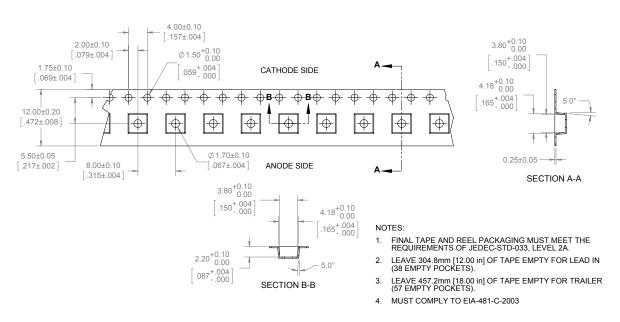
Mechanical Dimensions - B130 package

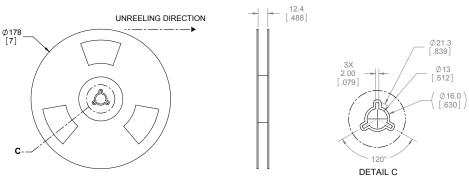


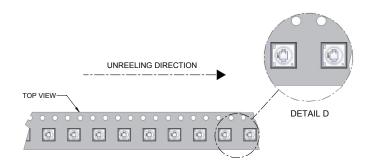
DWG-003005



Tape and Reel Outline







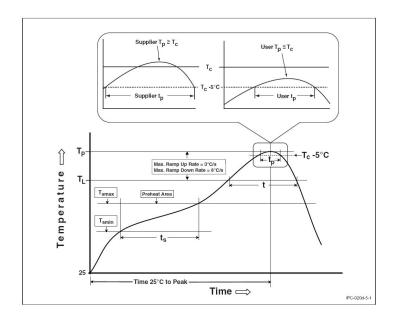


Soldering Profile

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts) Average ramp-up rate (Tsmax to Tp)	100 °C 150 °C 60-120 seconds 3 °C/second max	150 °C 200 °C 60-120 seconds 3 °C/second max
Liquidous temperature (TL) Time at liquidous (tL) Peak package body temperature (Tp)*	183 °C 60-150 seconds 230 °C ~235 °C	217 °C 60-150 seconds 255 °C ~260 °C
Classification temperature (Tc)	235 °C	260 °C
Time (tp) within 5 °C of the specified classification temperature (Tc)	20 seconds	30 seconds
Average ramp-down rate (Tp to Tsmax)	6 °C/second max	6 °C/second max
Time 25 °C to peak temperature	6 minutes max	8 minutes max

^{*} Tolerance for peak profile temperature(Tp) is defined as a supplier minimum and a user maximum.

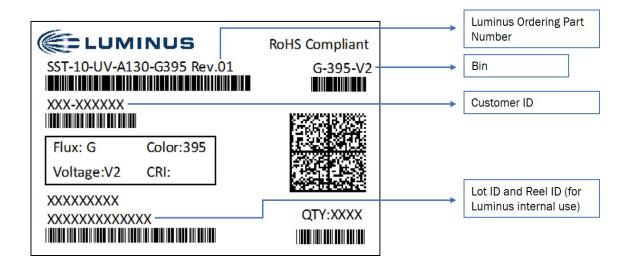
^{**} Tolerance for time at peak profile temperature(tp) is defined as asupplier minimum and a user maximum.





Packing and Shipping Specifications

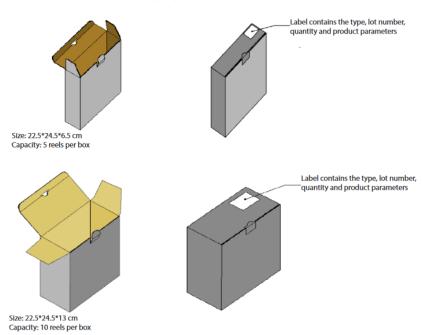
Product Label Specification



Sample label –for illustration only

Shipping Box

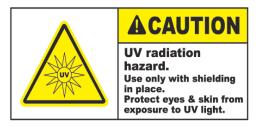
Box Packaging Information





Revision History

Rev	Date	Description of Change
01	06/01/2018	Initial Release
02	8/31/12018	Added "B130" version: updated ordering part numbers, characterization graphs and mechanical drawings



The products, their specifications and other information appearing in this document are subject to change by Luminus Devices without notice. Luminus Devices assumes no liability for errors that may appear in this document, and no liability otherwise arising from the application or use of the product or information contained herein. None of the information provided herein should be considered to be a representation of the fitness or suitability of the product for any particular application or as any other form of warranty. Luminus Devices' product warranties are limited to only such warranties as accompany a purchase contract or purchase order for such products. Nothing herein is to be construed as constituting an additional warranty. No information contained in this publication may be considered as a waiver by Luminus Devices of any intellectual property rights that Luminus Devices may have in such information.

This product is protected by U.S. Patents 6,831,302; 7,074,631; 7,083,993; 7,084,434; 7,098,589; 7,105,861; 7,138,666; 7,166,870; 7,166,871; 7,170,100; 7,196,354; 7,211,831; 7,262,550; 7,274,043; 7,301,271; 7,341,880; 7,344,903; 7,345,416; 7,348,603; 7,388,233; 7,391,059 Patents Pending in the U.S. and other countries.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for High Power LEDs - White category:

Click to view products by Osram manufacturer:

Other Similar products are found below:

G42180-08 B42180-08 STW8Q2PA-R5-HA SZ5-M1-W0-00-V3/W2-AA LTPL-P00DWS57 LZP-D0WW00-0000 CLM-9-30-90-36-AC32-F4-3 SZ5-M1-WW-C8-V1/V3-FA BXRC-27E2000-D-73 BXRC-27G2000-D-73 BXRC-30E1000-D-73 BXRC-30G2000-D-73 BXRC-40E1000-D-73 BXRE-30G2000-B-73 BXRE-30G2000-C-73 BXRE-50C2001-C-74 CXM-22-27-80-54-AC30-F4-3 XHP50B-00-0000-0D0UH245G XHP50B-00-0000-D0DUH245G MP-5050-8100-27-80 MP-5050-6100-65-80 MP-5050-6100-50-80 MP-5050-6100-40-80 MP-5050-6100-30-80 CXM-22-30-80-54-AC30-F4-3 LTW-2835SZK57 BXEM-50C0000-0-000 WW-WNA30TS-U1(M1) KW CSLPM2.CC-8L8M-4L8N KW CSLPM2.CC-8L8M-4O9Q KW DPLS32.SB-6H6J-E5P7-EG-Z264 L1V1-507003V500000 CXM-22-35-80-36-AC10-F3-3 KW3 CGLNM1.TG-Z6QF6-EBVFFCBB46-DFGA JB5630AWT-H-H65EA0000-NZ000001 XHP50B-00-0000-0D0UG430H CXM-22-35-90-54-AC40-F5-3 CXM-22-35-80-54-AC40-F5-3 OSM51206E1N-0.8T OSW43020C1C MP161611032290 MP-1616-2103-50-90 KW CULPM1.TG-Z6RF7-ebvFfcbB46-65G5 KW DMLS33.SG-Z6M7-EBVFFCBB46-8E8G-700-S XPGDWT-B1-0000-00EEA XHP70B-00-0000-0D0BP450E KW DMLN33.SG-7J7K-EBVFFCBB46-8E8G-200-S ASMT-MW05-NMNS1 ASMT-MW06-NMNZ1